

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

EMH2408 — General-Purpose Switching Device Applications

Features

- The EMH2408 incorporates a N-channel MOSFET that feature low ON-resistance and ultrahigh-speed switching, thereby enabling high-density mounting
- · 1.8V drive
- · Halogen free compliance

Specifications

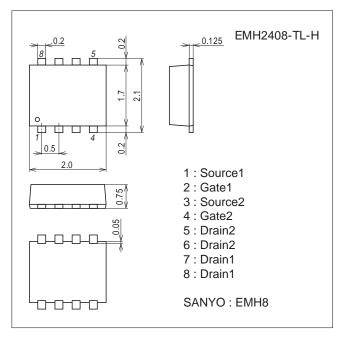
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ID		4	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	16	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm ² ×0.8mm) 1unit	1.0	W
Total Dissipation	PT	When mounted on ceramic substrate (900mm ² ×0.8mm)	1.2	W
Channel Temperature	Tch		150	C
Storage Temperature	Tstg		-55 to +150	C

This product is designed to "ESD immunity $< 200V^*$ ", so please take care when handling.

Package Dimensions

unit : mm (typ) 7045-006



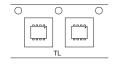
Product & Package Information

Package : EMH8JEITA, JEDEC : -

JEHA, JEDEC . -

• Minimum Packing Quantity : 3,000 pcs./reel

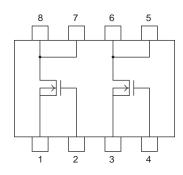
Packing Type : TL



Marking



Electrical Connection



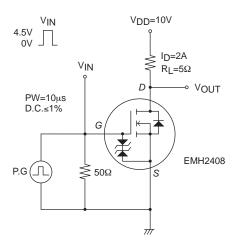
^{*} Machine Model

EMH2408

Electrical Characteristics at Ta=25°C

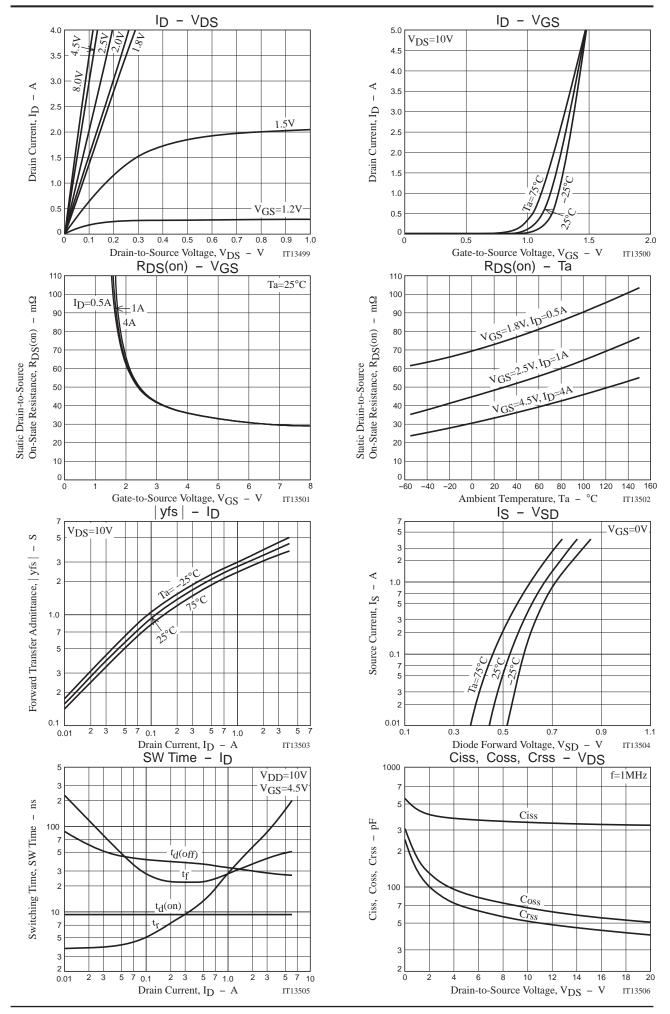
Parameter	Symbol	Conditions	Ratings			Unit	
Farameter	Symbol	Conditions	min	typ	max	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =20V, V _{GS} =0V			1	μΑ	
Gate-to-Source Leakage Current	IGSS	VGS=±8V, VDS=0V			±10	μΑ	
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	0.4		1.3	V	
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =2A	2.0	3.4		S	
	R _{DS} (on)1	I _D =4A, V _G S=4.5V)=4A, VGS=4.5V		45	mΩ	
Static Drain-to-Source On-State Resistance	R _{DS} (on)2	I _D =1A, V _G S=2.5V		49	67	mΩ	
	R _{DS} (on)3	I _D =0.5A, V _G S=1.8V		74	115	mΩ	
Input Capacitance	Ciss			345		pF	
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		67		pF	
Reverse Transfer Capacitance	Crss			52		pF	
Turn-ON Delay Time	t _d (on)			9.2		ns	
Rise Time	t _r	One are a liftered. The A. Circuit		60		ns	
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		30		ns	
Fall Time	tf			38		ns	
Total Gate Charge	Qg			4.7		nC	
Gate-to-Source Charge	Qgs	V _{DS} =10V, V _{GS} =4.5V, I _D =4A		0.65		nC	
Gate-to-Drain "Miller" Charge	Qgd			1.6		nC	
Diode Forward Voltage	V _{SD}	I _S =4A, V _{GS} =0V		0.8	1.2	V	

Switching Time Test Circuit

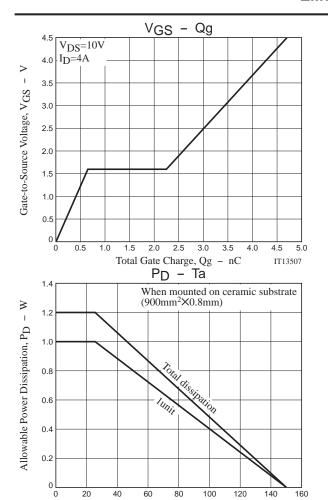


Ordering Information

Device	Device Package		memo		
EMH2408-TL-H EMH8		3,000pcs./reel	Pb Free and Halogen Free		

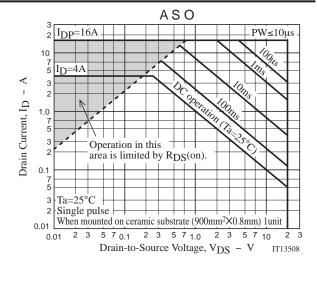


EMH2408



Ambient Temperature, Ta - °C

IT13509

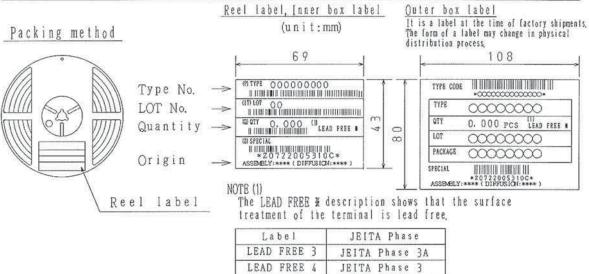


Embossed Taping Specification

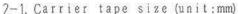
EMH2408-TL-H

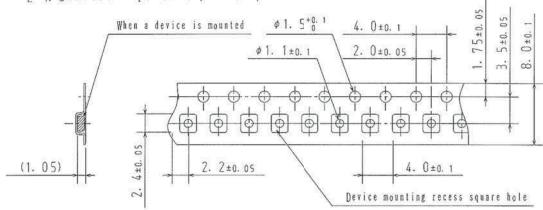
1. Packing Format

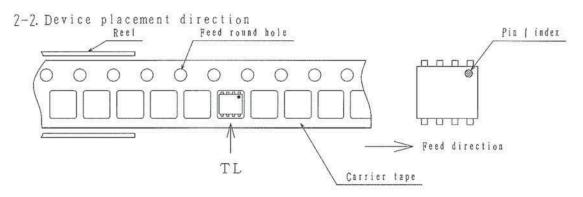
Package Name Carrier Tape Type	Carrier Tape	e Maximum Number of devices contained (pcs)			Packing format		
	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)		
ЕМН8	MCP4	3, 000	15, 000	90, 000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) $440 \times 195 \times 210$	



2. Taping configuration







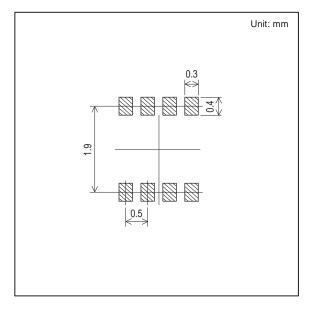
Those with pin 1 index on the feed hole side·····TL

Outline Drawing

EMH2408-TL-H

Mass (g) Unit 0.008 For reference mm 2.0+0.04 8 7 6 5 1.125+0.05

Land Pattern Example



Note on usage: Since the EMH2408 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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